# 103328-7 - ACTIVE

### AMPMODU | AMPMODU Headers

TE Internal #: 103328-7 PCB Mount Header, Vertical, Board-to-Board, 14 Position, .1 in [2.54 mm] Centerline, Breakaway, Tin-Lead, Through Hole - Solder, AMPMODU Headers

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### PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 14

Number of Rows: 2

### Features

### Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway

Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
Number of Positions	14	
Number of Rows	2	
Board-to-Board Configuration	Parallel	
Body Features		
Primary Product Color	Black	
Contact Features		
Mating Square Post Dimension	.64 mm[.025 in]	
	100 – 200 µin	
Contact Shape & Form	Square	
Contact Underplating Material	Nickel	

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PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin-Lead
Contact Mating Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.05 mm[.12 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	200
Packaging Type	Carton

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### Product Compliance

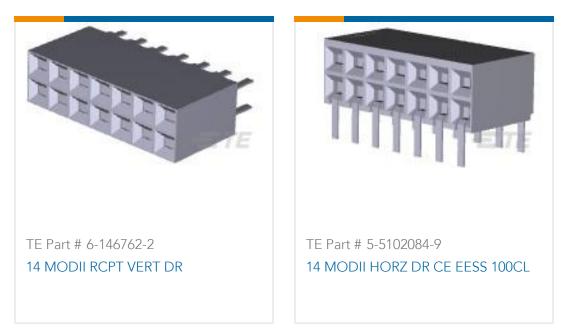
For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant	
EU ELV Directive 2000/53/EC	Not Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.	
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.	
Solder Process Capability	Wave solder capable to 240°C	

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**



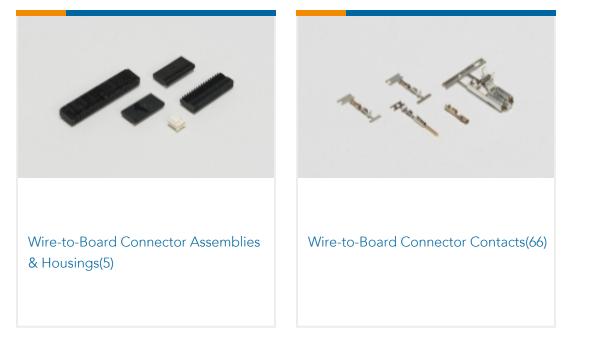
## Also in the Series AMPMODU Headers

**C** For support call+1 800 522 6752

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# Customers Also Bought



TE Part #3-641215-3 Polyester Vertical PCB Header: 2.54 mm, Unshrouded, No Mating Alignment	TE Part #3-1734592-6 FPC CONN. 0.5MM PITCH B/C, 36P	TE Part #2-746610-1 010 DIP PLUG 100CL TIN	TE Part #1-1437565-9 FSM1LPTR=NEW P/N
E TE			
TE Part #1-1825910-4 FSM8JH=6MM TACT SWITCH, HIGH TEMP	TE Part #5-534998-6 12 MODIV VRT DR CE 100/125	TE Part #63951-1 250 FASTON TAB TPBR	TE Part #5746613-2 14 DIP PLUG CONN-W/COVER

TE Part #A5003SL24P2

### Documents

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**Product Drawings** 14 MODII HDR DRST B/A .100CL English **CAD** Files 3D PDF 3D Customer View Model ENG\_CVM\_CVM\_103328-7\_U.2d\_dxf.zip English Customer View Model ENG\_CVM\_CVM\_103328-7\_U.3d\_igs.zip English Customer View Model ENG\_CVM\_CVM\_103328-7\_U.3d\_stp.zip English By downloading the CAD file I accept and agree to the **Terms and Conditions** of use. **Product Environmental Compliance** 

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